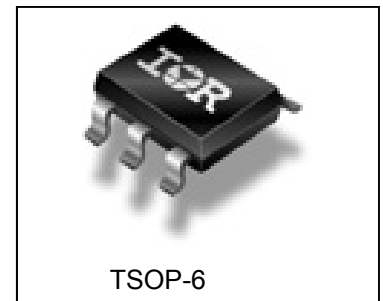
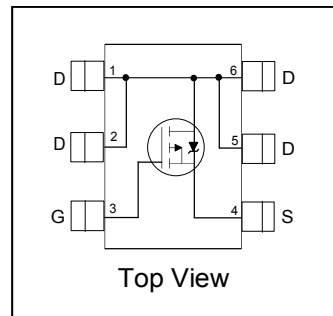


HEXFET® Power MOSFET

$V_{DSS}$	<b>-20</b>	<b>V</b>
$V_{GS}$	<b>± 12</b>	<b>V</b>
$R_{DS(on) \max}$ (@ $V_{GS} = -4.5V$ )	<b>32</b>	<b>mΩ</b>
$R_{DS(on) \max}$ (@ $V_{GS} = -2.5V$ )	<b>55</b>	<b>mΩ</b>
$Q_g$ (typical)	<b>12</b>	<b>nC</b>
$I_D$ (@ $T_A = 25^\circ C$ )	<b>-6.9</b>	<b>A</b>



### Applications

- Battery operated DC motor inverter MOSFET
- System/Load Switch

### Features

Industry-Standard TSOP-6 Package
RoHS Compliant Containing no Lead, no Bromide and no Halogen
MSL1, Consumer Qualification

results in  
⇒

### Benefits

Multi-Vendor Compatibility
Environmentally Friendlier
Increased Reliability

Base part number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
IRLTS2242TRPbF	TSOP-6	Tape and Reel	3000	IRLTS2242TRPbF

### Absolute Maximum Ratings


	Parameter	Max.	Units
$V_{DS}$	Drain-to-Source Voltage	- 20	V
$V_{GS}$	Gate-to-Source Voltage	± 12	
$I_D @ T_A = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V$	-6.9	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current, $V_{GS} @ 4.5V$	-5.5	
$I_{DM}$	Pulsed Drain Current ①	-55	
$P_D @ T_A = 25^\circ C$	Power Dissipation	2.0	W
$P_D @ T_A = 70^\circ C$	Power Dissipation	1.3	
	Linear Derating Factor	0.02	W/°C
$T_J$ $T_{STG}$	Operating Junction and Storage Temperature Range	-55 to + 150	°C

Notes ① through ③ are on page 2

**Static @ T<sub>J</sub> = 25°C (unless otherwise specified)**

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	-20	—	—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temp. Coefficient	—	9.4	—	mV/°C	Reference to 25°C, I <sub>D</sub> = -1mA
R <sub>DS(on)</sub>	Static Drain-to-Source On-Resistance	—	26	32	mΩ	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -6.9A ②
		—	45	55		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -5.5A ②
V <sub>GS(th)</sub>	Gate Threshold Voltage	-0.4	—	-1.1	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -10μA
ΔV <sub>GS(th)</sub>	Gate Threshold Voltage Coefficient	—	-3.8	—	mV/°C	
I <sub>DSS</sub>	Drain-to-Source Leakage Current	—	—	-1.0	μA	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V
		—	—	-150		V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125°C
I <sub>GSS</sub>	Gate-to-Source Forward Leakage	—	—	-100	nA	V <sub>GS</sub> = -12V
	Gate-to-Source Reverse Leakage	—	—	100		V <sub>GS</sub> = 12V
g <sub>fs</sub>	Forward Transconductance	8.5	—	—	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -5.5A
Q <sub>g</sub>	Total Gate Charge	—	12	—	nC	V <sub>DS</sub> = -10V
Q <sub>gs</sub>	Pre-V <sub>th</sub> Gate-to-Source Charge	—	1.5	—		V <sub>GS</sub> = -4.5V
Q <sub>gd</sub>	Gate-to-Drain Charge	—	4.3	—		I <sub>D</sub> = -5.5A
R <sub>G</sub>	Gate Resistance	—	17	—	Ω	
t <sub>d(on)</sub>	Turn-On Delay Time	—	5.8	—	ns	V <sub>DD</sub> = -10V, V <sub>GS</sub> = -4.5V I <sub>D</sub> = -5.5A R <sub>G</sub> = 6.8Ω
t <sub>r</sub>	Rise Time	—	18	—		
t <sub>d(off)</sub>	Turn-Off Delay Time	—	81	—		
t <sub>f</sub>	Fall Time	—	68	—		
C <sub>iss</sub>	Input Capacitance	—	905	—	pF	V <sub>GS</sub> = 0V V <sub>DS</sub> = -10V f = 1.0KHz
C <sub>oss</sub>	Output Capacitance	—	280	—		
C <sub>rss</sub>	Reverse Transfer Capacitance	—	200	—		

**Diode Characteristics**

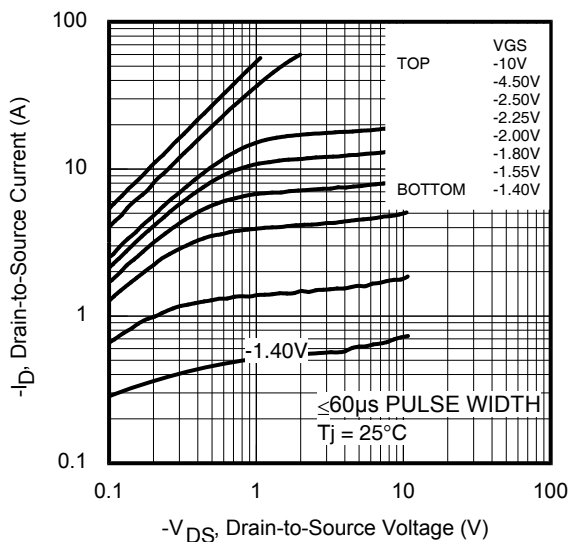
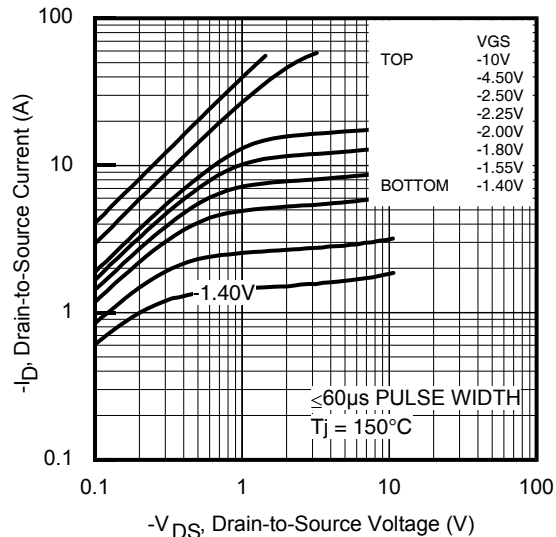
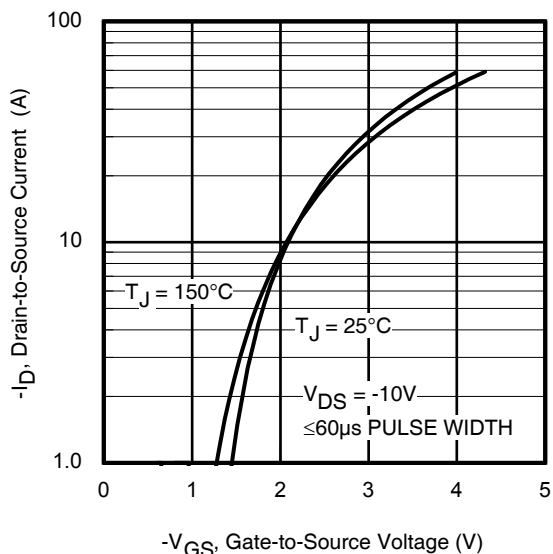
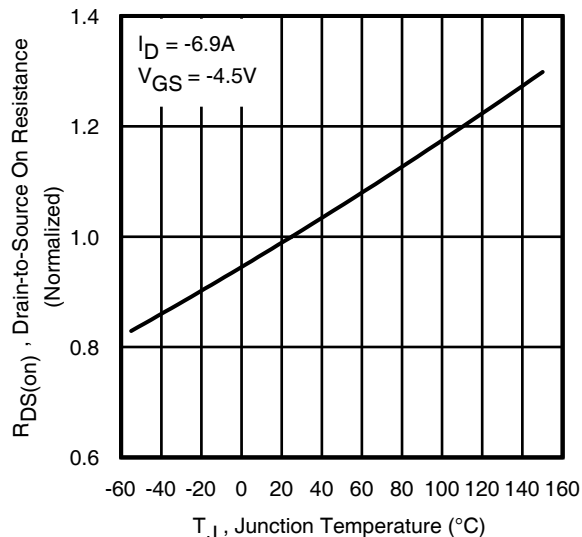
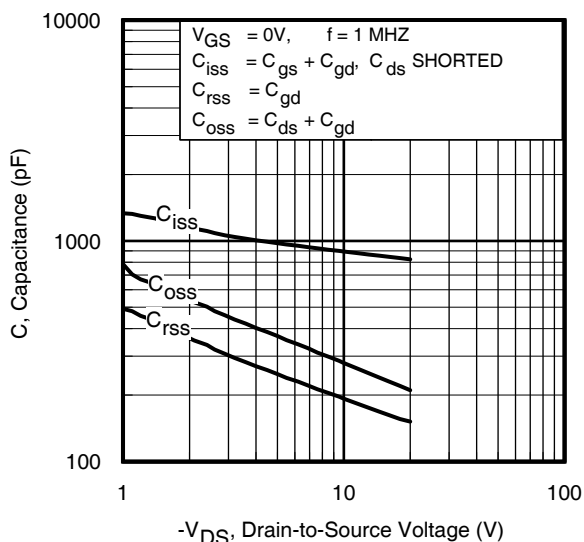
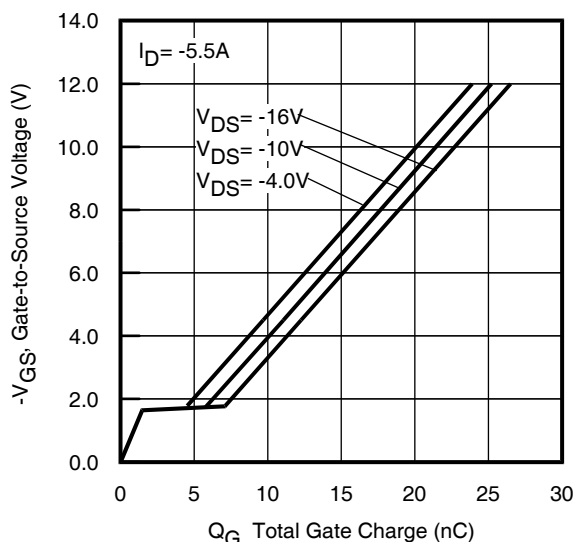
	Parameter	Min.	Typ.	Max.	Units	Conditions
I <sub>S</sub>	Continuous Source Current (Body Diode)	—	—	-2.0	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I <sub>SM</sub>	Pulsed Source Current (Body Diode) ①	—	—	-55		
V <sub>SD</sub>	Diode Forward Voltage	—	—	-1.2	V	T <sub>J</sub> = 25°C, I <sub>S</sub> = -5.5A, V <sub>GS</sub> = 0V ②
t <sub>rr</sub>	Reverse Recovery Time	—	41	62	ns	T <sub>J</sub> = 25°C, I <sub>F</sub> = -5.5A, V <sub>DD</sub> = -16V di/dt = 100A/μs ②
Q <sub>rr</sub>	Reverse Recovery Charge	—	16	24	nC	

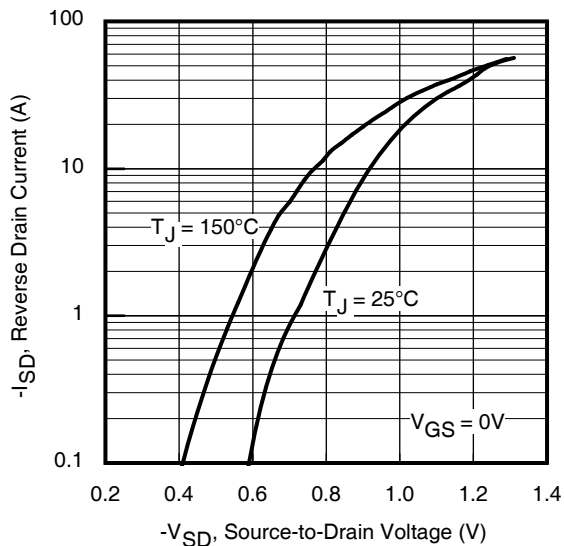
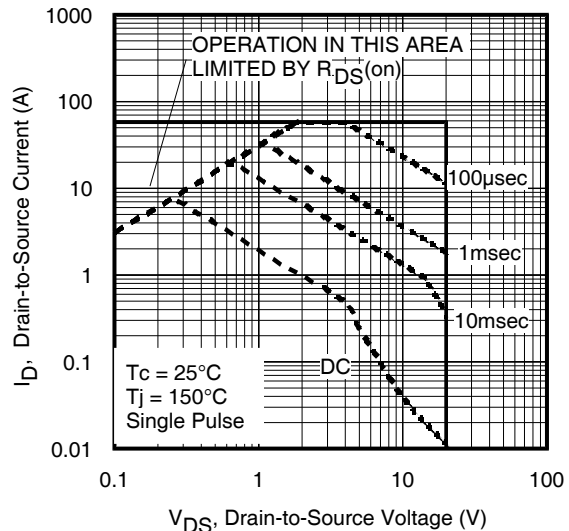
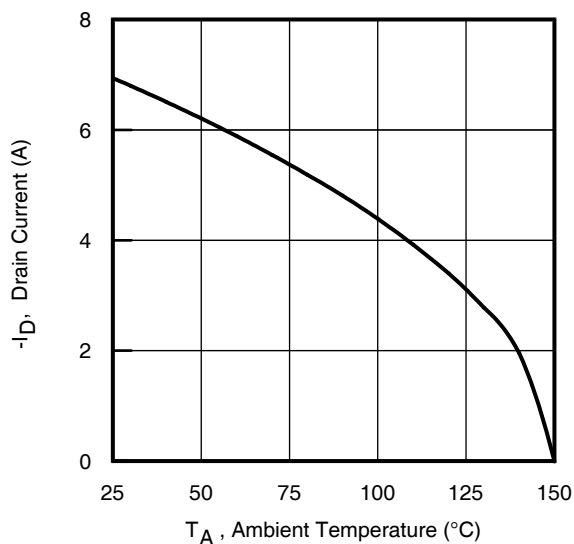
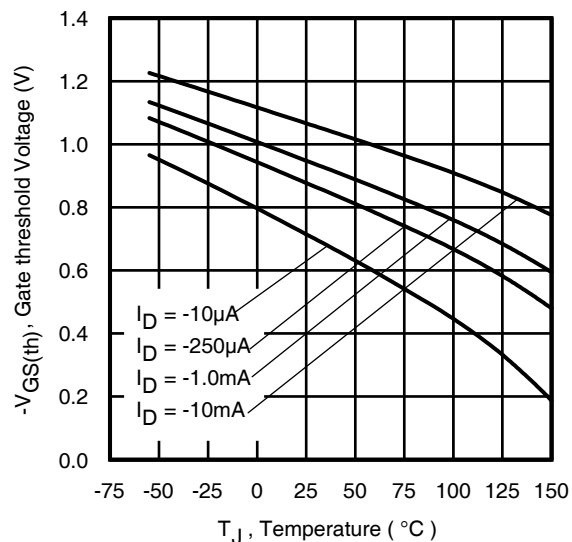
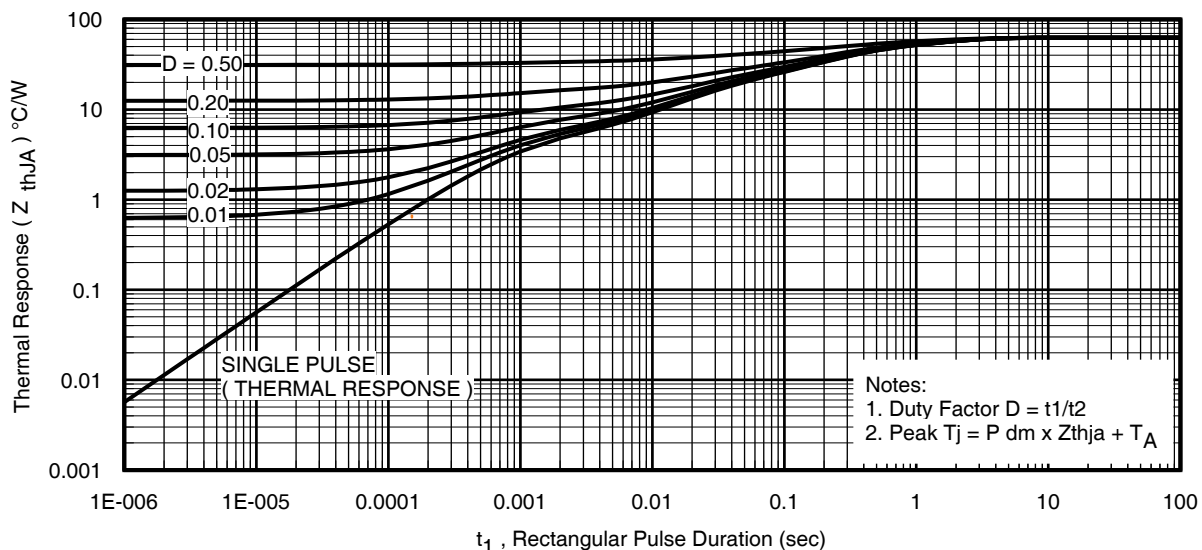
**Thermal Resistance**

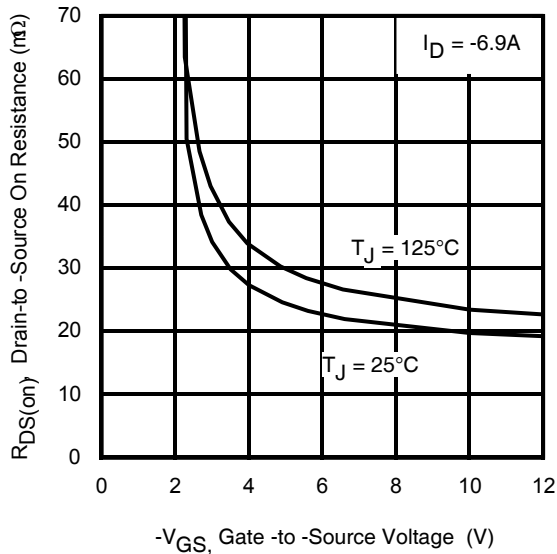
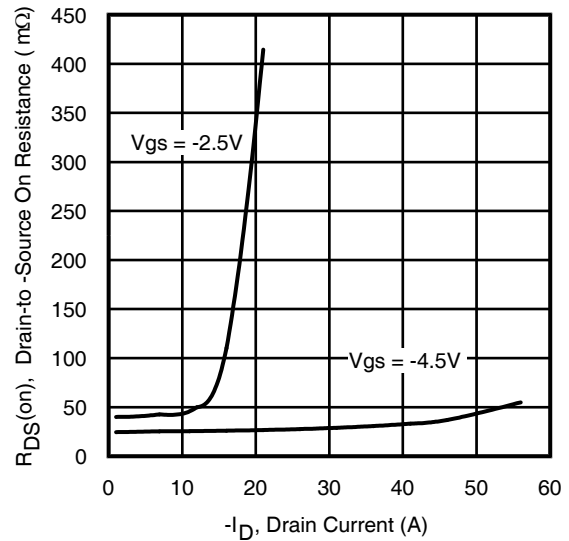
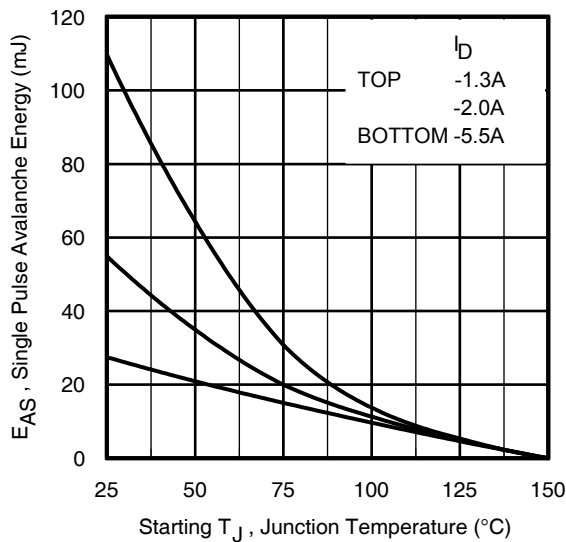
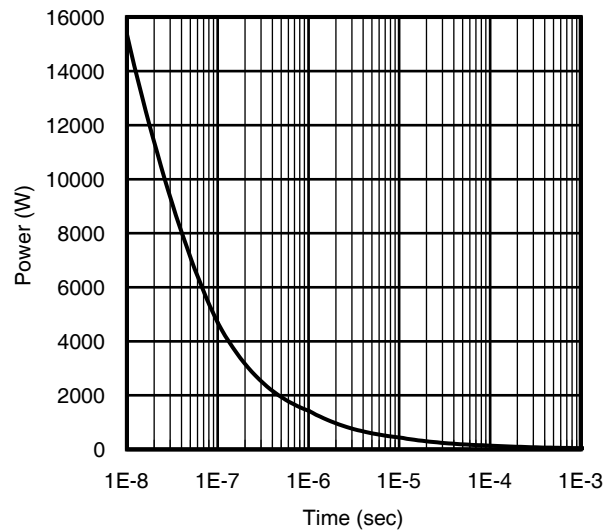
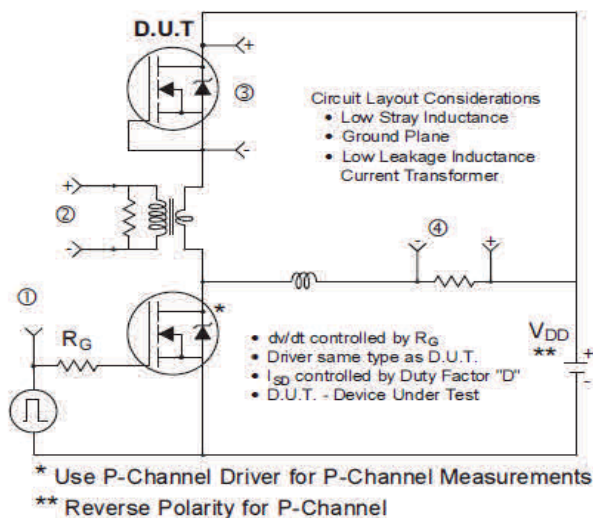
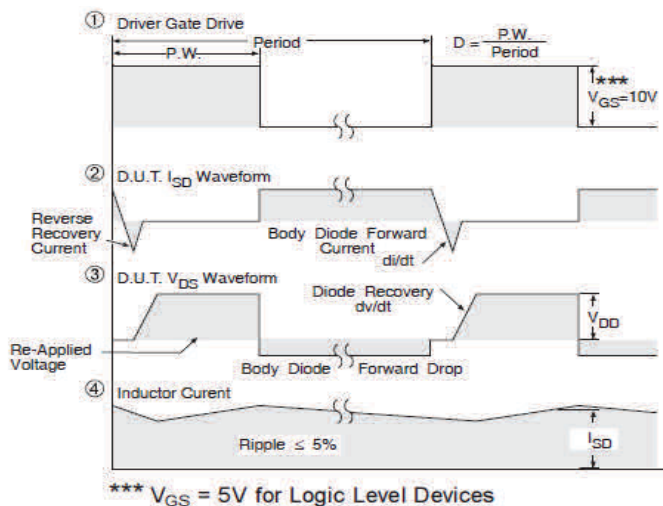
	Parameter	Typ.	Max.	Units
R <sub>θJA</sub>	Junction-to-Ambient ③	—	62.5	°C/W

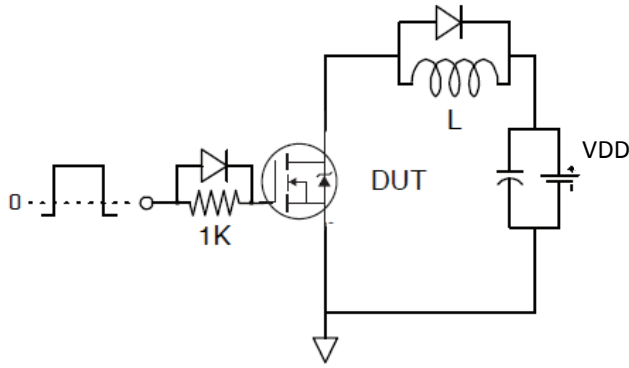
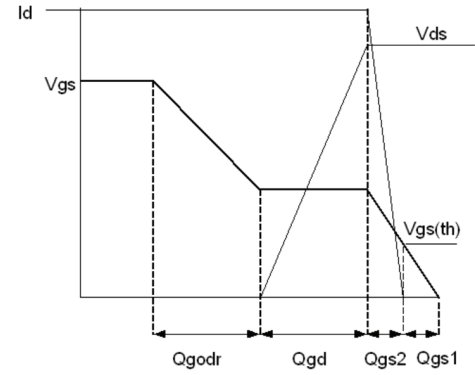
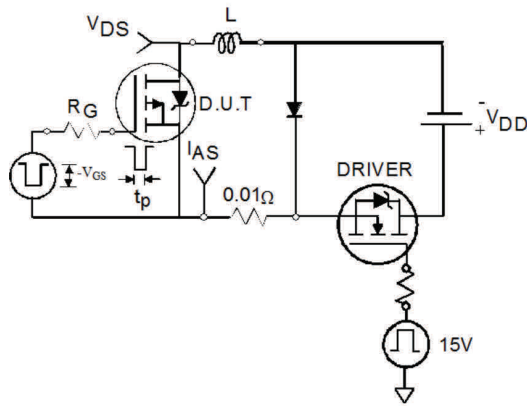
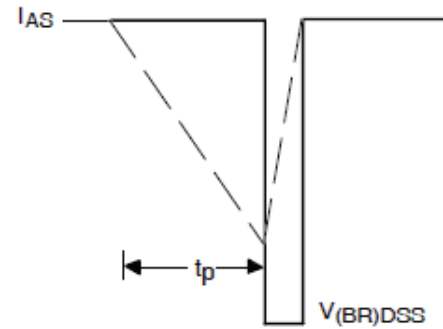
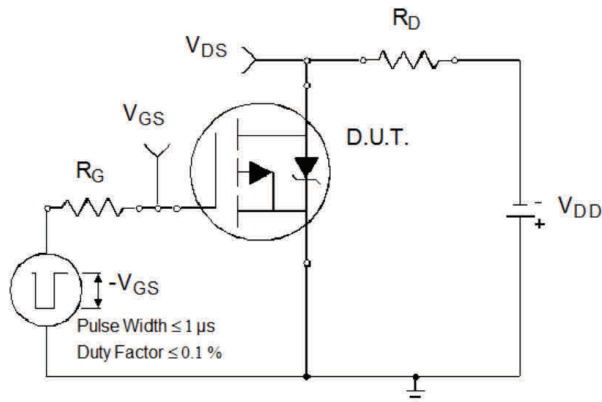
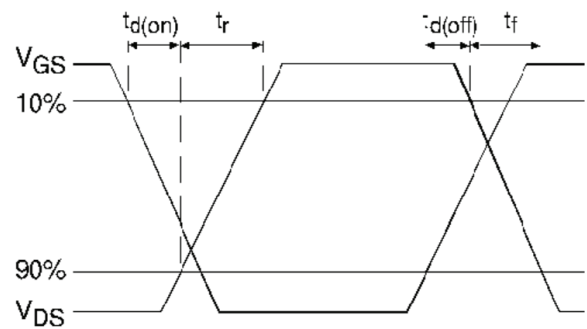
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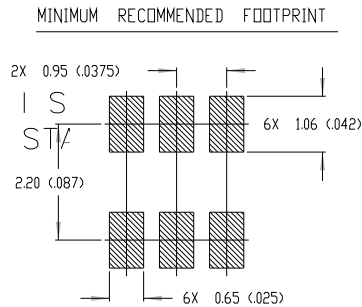
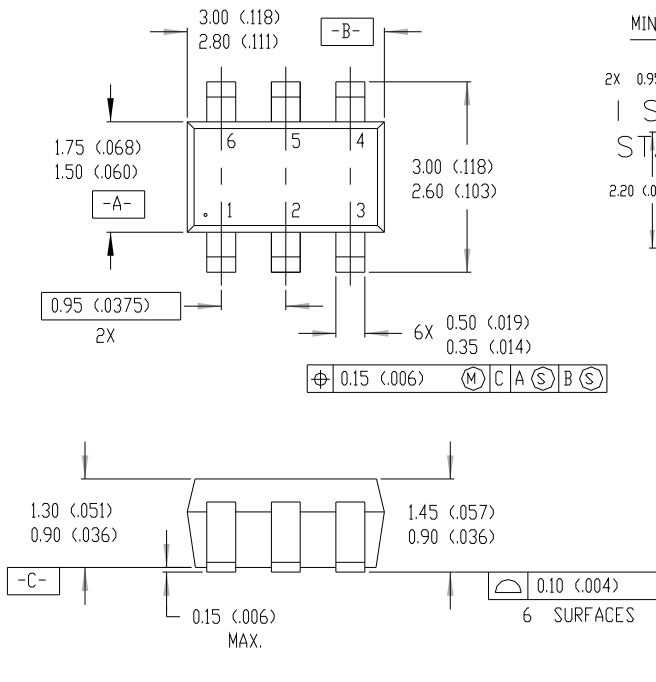
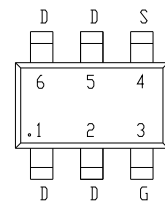
- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Pulse width ≤ 400μs; duty cycle ≤ 2%.
- ③ When mounted on 1 inch square PCB (FR-4). Please refer to AN-994 for more details: <http://www.irf.com/technical-info/appnotes/an-994.pdf>


**Fig 1. Typical Output Characteristics**

**Fig 2. Typical Output Characteristics**

**Fig 3. Typical Transfer Characteristics**

**Fig 4. Normalized On-Resistance vs. Temperature**

**Fig 5. Typical Capacitance vs. Drain-to-Source Voltage**

**Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage**

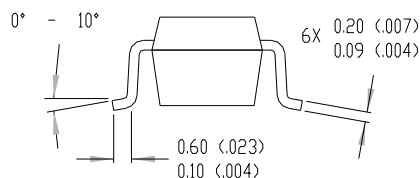
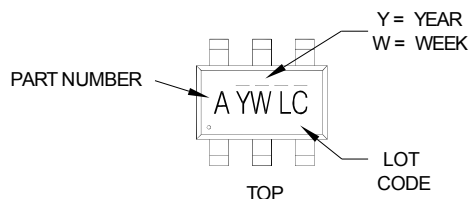

**Fig 7.** Typical Source-Drain Diode Forward Voltage

**Fig 8.** Maximum Safe Operating Area

**Fig 9.** Maximum Drain Current vs. Case Temperature

**Fig 10.** Threshold Voltage vs. Temperature

**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case


**Fig 12. On-Resistance vs. Gate Voltage**

**Fig 13. Typical On-Resistance vs. Drain Current**

**Fig 14. Maximum Avalanche Energy vs. Drain Current**

**Fig 15. Typical Power vs. Time**

**Fig 16. Diode Reverse Recovery Test Circuit for P-Channel HEXFET® Power MOSFETs**



**Fig 17a.** Gate Charge Test Circuit

**Fig 17b.** Gate Charge Waveform

**Fig 18a.** Unclamped Inductive Test Circuit

**Fig 18b.** Unclamped Inductive Waveforms

**Fig 19a.** Switching Time Test Circuit

**Fig 19b.** Switching Time Waveforms

**TSOP-6 Package Outline**

**LEAD ASSIGNMENTS**

**NOTES:**

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).


**TSOP-6 Part Marking Information**

**PART NUMBER CODE REFERENCE:**

- |              |                    |
|--------------|--------------------|
| A = SI3443DV | O = IRLTS6342TRPBF |
| B = IRF5800  | P = IRF58342TRPBF  |
| C = IRF5850  | R = IRF58342TRPBF  |
| D = IRF5851  | S = Not applicable |
| E = IRF5852  | T = IRLTS2242TRPBF |
| F = IRF5801  |                    |
| G = IRF5803  |                    |
| H = IRF5804  |                    |
| I = IRF5805  |                    |
| J = IRF5806  |                    |
| K = IRF5810  |                    |
| N = IRF5802  |                    |

Note: A line above the work week (as shown here) indicates Lead-Free.

**DATE CODE MARKING INSTRUCTIONS**

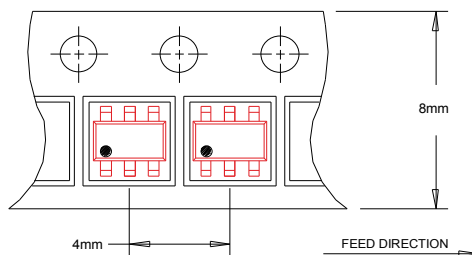
WW = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

YEAR	Y	WORK WEEK	W	
2011	2001	1	01	A
2012	2002	2	02	B
2013	2003	3	03	C
2014	2004	4	04	D
2015	2005	5		
2016	2006	6		
2017	2007	7		
2018	2008	8		
2019	2009	9		
2020	2010	0	24	X
			25	Y
			26	Z

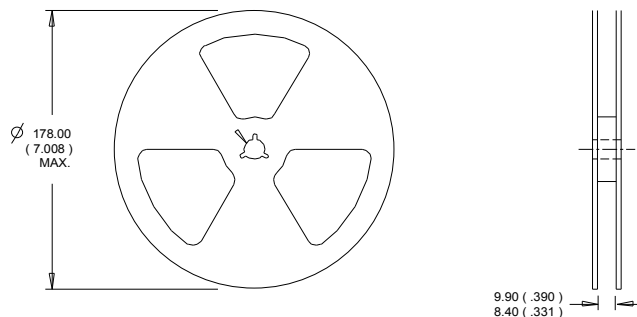
WW = (27-52) IF PRECEDED BY A LETTER

YEAR	Y	WORK WEEK	W	
2011	2001	A	27	A
2012	2002	B	28	B
2013	2003	C	29	C
2014	2004	D	30	D
2015	2005	E		
2016	2006	F		
2017	2007	G		
2018	2008	H		
2019	2009	J		
2020	2010	K	50	X
			51	Y
			52	Z

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

**TSOP-6 Tape and Reel Information**


NOTES:  
1. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:  
1. CONTROLLING DIMENSION : MILLIMETER.  
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at <http://www.irf.com/package/>

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>	Consumer <sup>††</sup> (per JEDEC JESD47F <sup>†††</sup> guidelines)	
<b>Moisture Sensitivity Level</b>	TSOP-6	MSL1 (per IPC/JEDEC J-STD-020D <sup>††</sup> )
<b>RoHS Compliant</b>	Yes	

<sup>†</sup> Qualification standards can be found at International Rectifier's web site: <http://www.irf.com/product-info/reliability/>

<sup>††</sup> Higher qualification ratings may be available should the user have such requirements.

Please contact your International Rectifier sales representative for further information:

<http://www.irf.com/whoto-call/salesrep/>

<sup>†††</sup> Applicable version of JEDEC standard at the time of product release.

**Revision History**

Date	Comment
11/18/2014	<ul style="list-style-type: none"> <li>Updated data sheet with IR corporate template.</li> <li>Updated figure 12 on page 5 for <math>V_{GS}</math> from "20V" to "12V" due to error.</li> </ul>



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Authorized Distributor

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[IRLTS2242TRPBF](#)